

# ***SPRINGFIELD LAKESHORE IMPROVEMENT ASSOCIATION SCHOLARSHIP APPLICATION***

**Return this completed form and all required attachments to:**  
Springfield Lake Shore Improvement Association, Scholarship Program  
P.O. Box 4132, Springfield, IL 62708  
[www.lakespringfield.us](http://www.lakespringfield.us)

Date of Application: \_\_\_\_\_

**Postmark Deadline: April 1, 2021**

## **1. Personal Information**

Full Name: \_\_\_\_\_

Date of Birth: \_\_\_\_\_

Address \_\_\_\_\_  
\_\_\_\_\_

Phone number: \_\_\_\_\_

Email Address: \_\_\_\_\_

Name and Address of Parent or Legal Guardian: \_\_\_\_\_

## **2. College Plans**

Name of college/university you plan to attend: \_\_\_\_\_

## **3. References**

Please list at least two references and provide a letter of recommendation from each supporting your application. References must be from individuals who are not related to you by birth or marriage.

Name: \_\_\_\_\_

Phone number: \_\_\_\_\_

Association/relationship: \_\_\_\_\_

Name: \_\_\_\_\_

Phone number: \_\_\_\_\_

Association/relationship: \_\_\_\_\_

## **4. Written Statement**

Submit an essay (not over 500 words) on: "What Lake Springfield Means to Me."

(Winning essays will be posted on the Springfield Lake Shore Improvement Association website).

## **5. Transcript and List of Community Service and Extra-Curricular Activities**

Submit an official copy of your high school transcript. Include a list of all extra-curricular and community service activities with your application.

By signing this form, I acknowledge that I am a graduating senior in high school and will be attending a two- or four-year college or university in the fall of 2021.

Signed: \_\_\_\_\_

Date: \_\_\_\_\_

Parent or Legal Guardian: Date: \_\_\_\_\_

Date: \_\_\_\_\_

Submitted materials remain the property of SLSIA for their use.